

plastic, low profile quad; flat leaded package; 44 terminals; 0.80 mm pitch; 10 mm x 10 mm x 1.4 mm body 15 December 2016 Package informati

Package information

1. Package summary

Terminal position code	Q (quad)
Package type descriptive code	LQFP
Package type industry code	LQFP44
Package style descriptive code	LQFP (low profile quad flat package)
Package body material type	P (plastic)
JEDEC package outline code	MS-026-BCB
Mounting method type	S (surface mount)
Issue date	26-5-2016
Manufacturer package code	98ASS23225W

Table 1. Package summary

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	-	-	10	-	mm
E	package width	-	-	10	-	mm
A	seated height	-	-	1.4	1.6	mm
е	nominal pitch	-	-	0.8	-	mm
n ₂	actual quantity of termination	-	-	44	-	

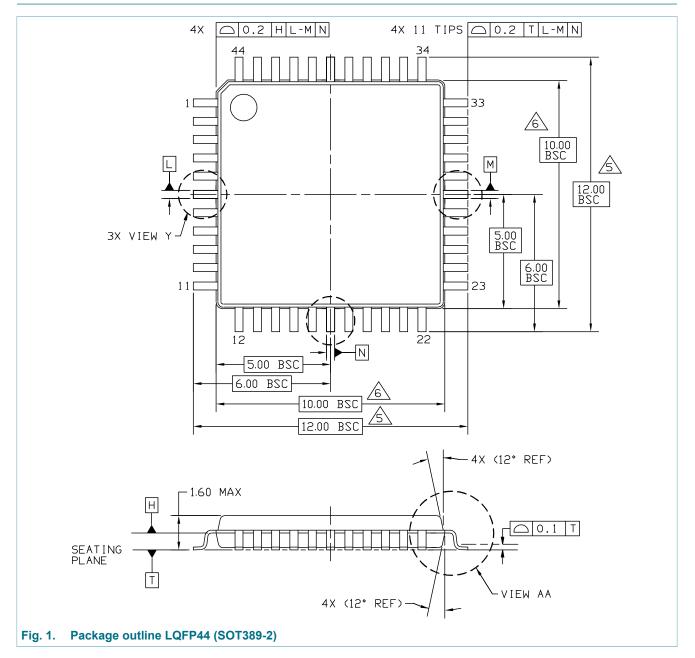


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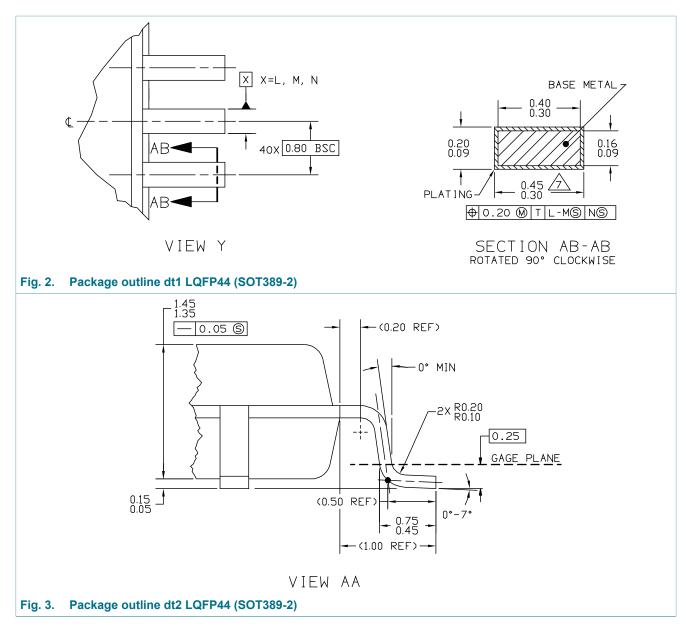
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2. Package outline



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NOTES:

- 1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DATUM PLANE H IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
- 4. DATUMS L, M AND N TO BE DETERMINED AT DATUM PLANE H.

 $\sqrt{5}$ dimensions to be determined at seating plane t.

6. DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 PER SIDE. DIMENSIONS DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.

The dimension does not include dambar protrusion. Dambar protrusion shall not cause the dimension to exceed 0.53. Minimum space between protrusion and Adjacent lead or protrusion 0.07.

Fig. 4. Package outline note LQFP44 (SOT389-2)

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3. Legal information

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